

## DESCRIPTION

The MP2372 is a 925kHz step-down regulator with a built-in power MOSFET. It achieves 3A continuous output current over a wide input supply range with excellent load and line regulation.

Current mode operation provides fast transient response and eases loop stabilization.

Fault condition protection includes cycle-by-cycle current limiting and thermal shutdown. Adjustable soft-start reduces the stress on the input source at turn-on. In shutdown mode, the regulator draws 20 $\mu$ A of supply current.

The MP2372 is available in an 8-pin SOIC package with an exposed pad, and requires a minimum number of readily available external components to complete a 3A step-down DC to DC converter solution.

## FEATURES

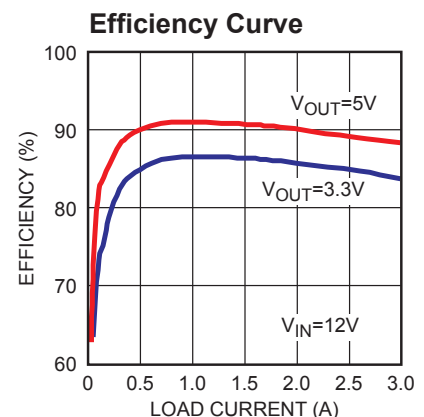
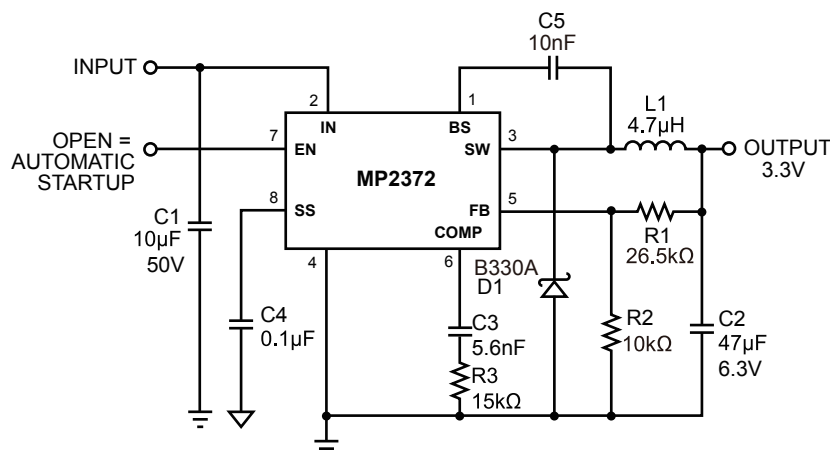
- 3A Continuous Output Current, 4A Peak Output Current
- Programmable Soft-Start
- 100m $\Omega$  Internal Power MOSFET Switch
- Stable with Low ESR Output Ceramic Capacitors
- Up to 91% Efficiency
- 20 $\mu$ A Shutdown Mode
- Fixed 925kHz Frequency
- Thermal Shutdown
- Cycle-by-Cycle Over Current Protection
- Wide 4.5V to 28V Operating Input Range
- Output is Adjustable From 0.92V to 21V
- Under Voltage Lockout

## APPLICATIONS

- Distributed Power Systems
- Battery Chargers
- Pre-Regulator for Linear Regulators

All MPS parts are lead-free and adhere to the RoHS directive. For MPS green status, please visit MPS website under Quality Assurance. "MPS" and "The Future of Analog IC Technology" are Registered Trademarks of Monolithic Power Systems, Inc.

## TYPICAL APPLICATION



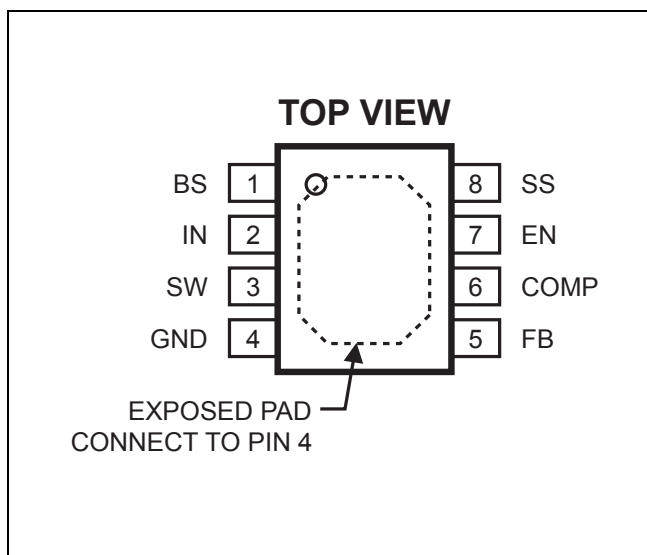
## ORDERING INFORMATION

Part Number*	Package	Top Marking	Free Air Temperature (T <sub>A</sub> )
MP2372DN	SOIC8N	MP2372DN	–40°C to +85°C

\* For Tape & Reel, add suffix –Z (eg. MP2372DN–Z).

For RoHS compliant packaging, add suffix –LF (eg. MP2372DN–LF–Z)

## PACKAGE REFERENCE



### ABSOLUTE MAXIMUM RATINGS <sup>(1)</sup>

Supply Voltage V <sub>IN</sub>	–0.3V to +30V
Switch Voltage V <sub>SW</sub>	–1V (–5V for 10ns) to 31V
Boost Voltage V <sub>BS</sub>	V <sub>SW</sub> + 6V
All Other Pins	–0.3V to +6V
Continuous Power Dissipation (T <sub>A</sub> = +25°C) <sup>(2)</sup>	2.5W
Junction Temperature	150°C
Lead Temperature	260°C
Storage Temperature	–65°C to +150°C

### Recommended Operating Conditions <sup>(3)</sup>

Input Voltage V <sub>IN</sub>	4.5V to 28V
Operating Junct. Temp (T <sub>J</sub> )	–40°C to +125°C

### Thermal Resistance <sup>(4)</sup>

	θ <sub>JA</sub>	θ <sub>JC</sub>
SOIC8N	50	10

#### Notes:

- Exceeding these ratings may damage the device
- The maximum allowable power dissipation is a function of the maximum junction temperature T<sub>J</sub>(MAX), the junction-to-ambient thermal resistance θ<sub>JA</sub>, and the ambient temperature T<sub>A</sub>. The maximum allowable continuous power dissipation at any ambient temperature is calculated by P<sub>D</sub>(MAX) = (T<sub>J</sub>(MAX) – T<sub>A</sub>) / θ<sub>JA</sub>. Exceeding the maximum allowable power dissipation will cause excessive die temperature, and the regulator will go into thermal shutdown. Internal thermal shutdown circuitry protects the device from permanent damage.
- The device is not guaranteed to function outside of its operating conditions.
- Measured on JESD51-7, 4-layer PCB.

## ELECTRICAL CHARACTERISTICS

$V_{IN} = 12V$ ,  $T_A = +25^{\circ}C$ , unless otherwise noted.

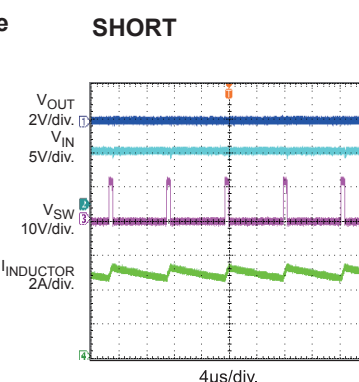
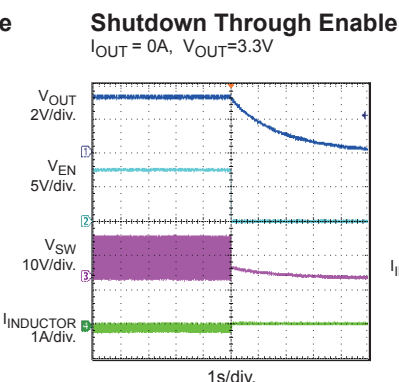
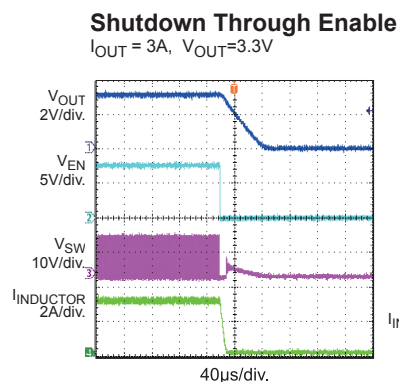
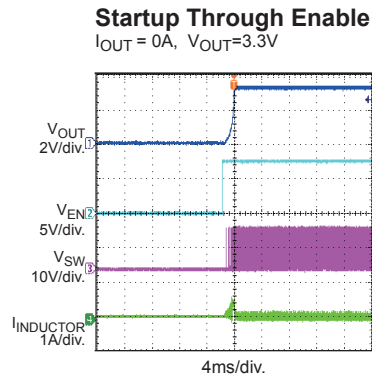
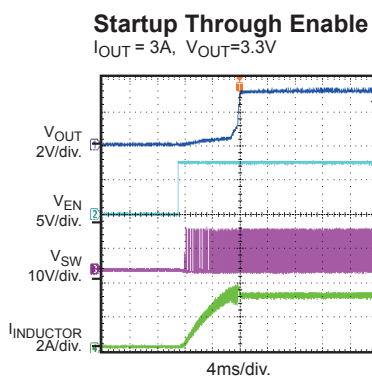
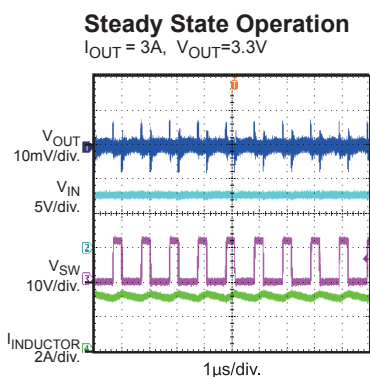
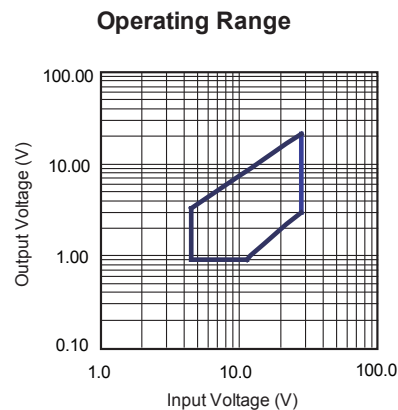
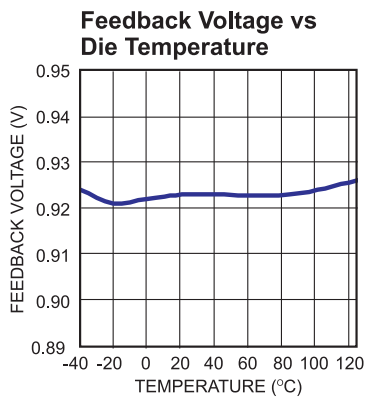
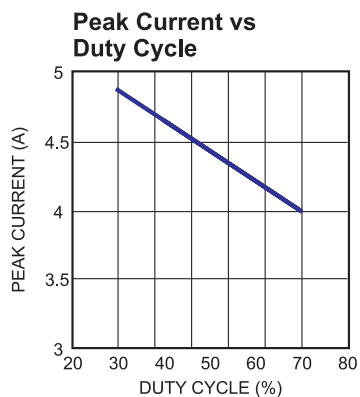
Parameters	Symbol	Condition	Min	Typ	Max	Units
Shutdown Supply Current	$I_{supply}$	$V_{EN} = 0V$		20	30	$\mu A$
Quiescent Supply Current	$I_q$	$V_{EN} = 3V$ , $V_{FB} = 1.4V$		1.3	1.5	mA
Feedback Voltage	$V_{FB}$	$4.5V \leq V_{IN} \leq 28V$ , $V_{COMP} < 2V$	0.892	0.920	0.948	V
Error Amplifier Voltage Gain	$A_{VEA}$			400		V/V
Error Amplifier Transconductance	$G_{EA}$	$\Delta I_{COMP} = \pm 10\mu A$		690		$\mu A/V$
High-Side Switch-On Resistance	$R_{DS(ON)1}$			100		m $\Omega$
Low-Side Switch-On Resistance	$R_{DS(ON)2}$			10		$\Omega$
High-Side Switch Leakage Current		$V_{EN} = 0V$ , $V_{SW} = 0V$		0.1	10	$\mu A$
Short Circuit Current Limit				6.5		A
Current Sense to COMP Transconductance	$G_{CS}$			6.0		A/V
Oscillation Frequency	$f_s$			925		KHz
Short Circuit Oscillation Frequency		$V_{FB} = 0V$		110		KHz
Maximum Duty Cycle	$D_{MAX}$	$V_{FB} = 0.8V$	76	80	99	%
Minimum On Time	$T_{ON}$			130		ns
EN Threshold Voltage			0.9	1.2	1.5	V
Enable Pull Up Current		$V_{EN} = 0V$	0.9	1.6	2.3	$\mu A$
Under Voltage Lockout Threshold Rising			2.3	2.6	2.9	V
Under Voltage Lockout Threshold Hysteresis				210		mV
Soft-Start Period		$C_{SS} = 0.1\mu F$ $L = 10\mu H$ $C_O = 47\mu F$ $I_O = 3A(CC)$		10		ms
Thermal Shutdown				160		$^{\circ}C$

## PIN FUNCTIONS

Pin #	Name	Description
1	BS	High-Side Gate Drive Boost Input. BS supplies the drive for the high-side N-Channel MOSFET switch. Connect a 10nF or greater capacitor from SW to BS to power the high side switch.
2	IN	Power Input. IN supplies the power to the IC, as well as the step-down converter switches. Drive IN with a 4.5V to 28V power source. Bypass IN to GND with a suitably large capacitor to eliminate noise on the input to the IC. See <i>Input Capacitor</i>
3	SW	Power Switching Output. SW is the switching node that supplies power to the output. Connect the output LC filter from SW to the output load. Note that a capacitor is required from SW to BS to power the high-side switch.
4	GND	Ground. Connect the exposed pad on backside to Pin 4.
5	FB	Feedback Input. FB senses the output voltage to regulate said voltage. Drive FB with a resistive voltage divider from the output voltage. The feedback threshold is 0.92V. See <i>Setting the Output Voltage</i>
6	COMP	Compensation Node. COMP is used to compensate the regulation control loop. Connect a series RC network from COMP to GND to compensate the regulation control loop. In some cases, an additional capacitor from COMP to GND is required. See <i>Compensation</i>
7	EN	Enable/UVLO. A voltage greater than 2.9V enables operation. For complete low current shutdown the EN pin voltage needs to be at less than 900mV. When the voltage on EN exceeds 1.2V, the internal regulator will be enabled and the soft-start capacitor will begin to charge. The MP2372 will start switching after the EN pin voltage reaches 2.9V.
8	SS	Soft-Start Control Input. SS controls the soft start period. Connect a capacitor from SS to GND to set the soft-start period. A 0.1μF capacitor sets the soft-start period to 10ms.

## ELECTRICAL CHARACTERISTICS

$V_{IN} = 12V$ ,  $C1 = 10\mu F$ ,  $C2 = 47\mu F$ ,  $L = 10\mu H$  and  $T_A = +25^\circ C$ , unless otherwise noted.



## OPERATION

The MP2372 is a current-mode step-down regulator. It regulates input voltages from 4.5V to 28V down to an output voltage as low as 0.92V, and is able to supply up to 3A of load current.

The MP2372 uses current-mode control to regulate the output voltage. The output voltage is measured at FB through a resistive voltage divider and amplified through the internal error amplifier. The output current of the transconductance error amplifier is presented at COMP where a network compensates the regulation control system. The voltage at COMP is compared to the switch current measured internally to control the output voltage.

The converter uses an internal N-Channel MOSFET switch to step-down the input voltage to the regulated output voltage. Since the MOSFET requires a gate voltage greater than the input voltage, a boost capacitor connected between SW and BS drives the gate. The capacitor is internally charged while SW is low.

An internal 10Ω switch from SW to GND is used to insure that SW is pulled to GND when SW is low to fully charge the BS capacitor.

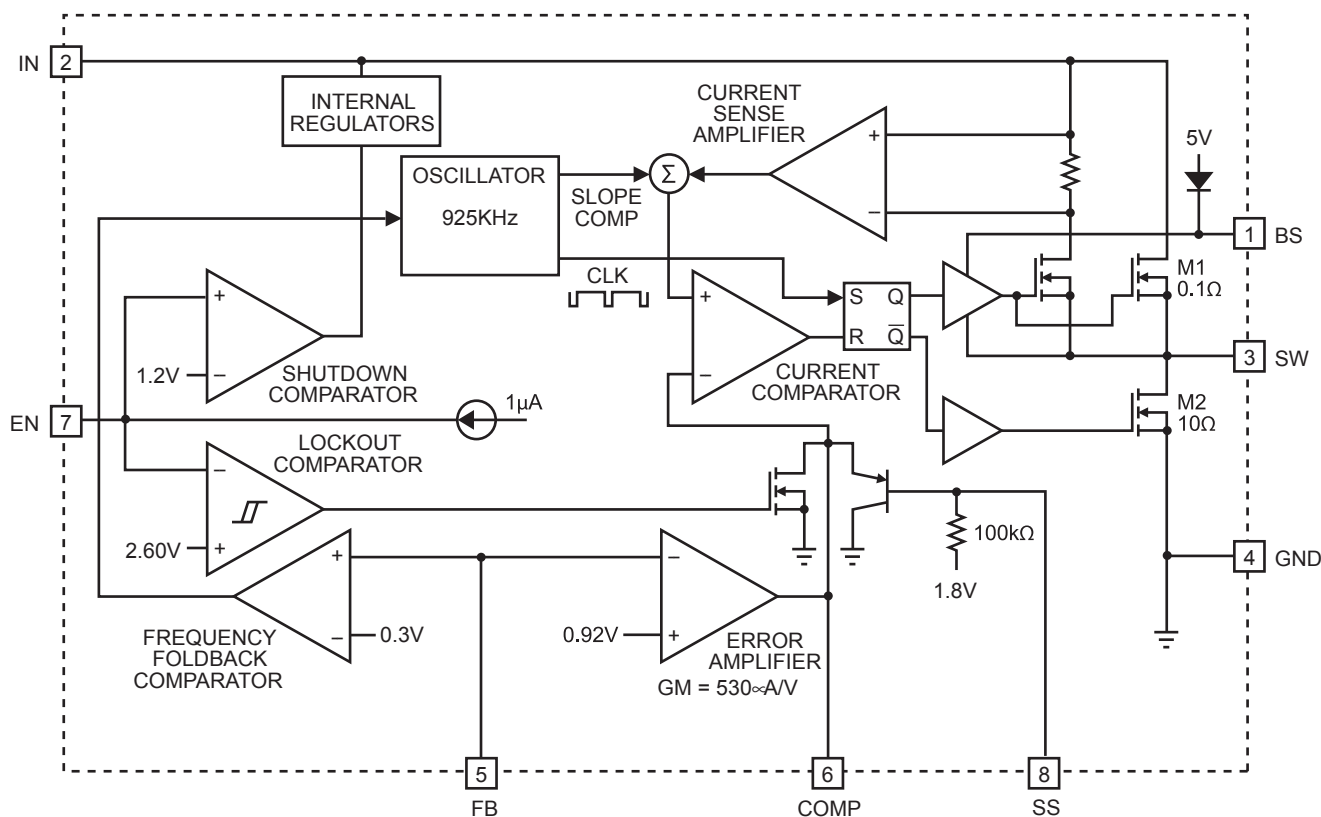


Figure 1—Functional Block Diagram

## APPLICATION INFORMATION

### COMPONENT SELECTION

(Refer to Figure 5)

#### Setting the Output Voltage

The output voltage is set using a resistive voltage divider from the output voltage to FB pin. The voltage divider divides the output voltage down to the feedback voltage by the ratio:

$$V_{FB} = V_{OUT} \frac{R2}{R1 + R2}$$

Where  $V_{FB}$  is the feedback voltage and  $V_{OUT}$  is the output voltage.

Thus the output voltage is:

$$V_{OUT} = 0.92 \times \frac{R1 + R2}{R2}$$

A typical value for R2 can be as high as 100kΩ, but a typical value is 10kΩ. Using that value, R1 is determined by:

$$R1 = 10.87 \times (V_{OUT} - 0.92)(k\Omega)$$

#### Inductor

The inductor is required to supply constant current to the output load while being driven by the switched input voltage. A larger value inductor will result in less ripple current that will result in lower output ripple voltage. However, the larger value inductor will have a larger physical size, higher series resistance, and/or lower saturation current. A good rule for determining the inductance to use is to allow the peak-to-peak ripple current in the inductor to be approximately 30% of the maximum switch current limit. Also, make sure that the peak inductor current is below the maximum switch current limit. The inductance value can be calculated by:

$$L1 = \frac{V_{OUT}}{f_S \times \Delta I_L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

Where  $V_{IN}$  is the input voltage,  $f_S$  is the 925kHz switching frequency and  $\Delta I_L$  is the peak-to-peak inductor ripple current.

Choose an inductor that will not saturate under the maximum inductor peak current. The peak inductor current can be calculated by:

$$I_{LP} = I_{LOAD} + \frac{V_{OUT}}{2 \times f_S \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

Where  $I_{LOAD}$  is the load current.

Table 1 lists a number of suitable inductors from various manufacturers. The choice of which style inductor to use mainly depends on the price vs. size requirements and any EMI requirement.

**Table 1—Inductor Selection Guide**

Vendor/ Model	Core Type	Core Material	Package Dimensions (mm)		
			W	L	H
Sumida					
CR75	Open	Ferrite	7.0	7.8	5.5
CDH74	Open	Ferrite	7.3	8.0	5.2
CDRH5D28	Shielded	Ferrite	5.5	5.7	5.5
CDRH5D28	Shielded	Ferrite	5.5	5.7	5.5
CDRH6D28	Shielded	Ferrite	6.7	6.7	3.0
CDRH104R	Shielded	Ferrite	10.1	10.0	3.0
Toko					
D53LC Type A	Shielded	Ferrite	5.0	5.0	3.0
D75C	Shielded	Ferrite	7.6	7.6	5.1
D104C	Shielded	Ferrite	10.0	10.0	4.3
D10FL	Open	Ferrite	9.7	1.5	4.0
Coilcraft					
DO3308	Open	Ferrite	9.4	13.0	3.0
DO3316	Open	Ferrite	9.4	13.0	5.1

#### Output Rectifier Diode

The output rectifier diode supplies the current to the inductor when the high-side switch is off. To reduce losses due to the diode forward voltage and recovery times, use a Schottky diode.

Choose a diode whose maximum reverse voltage rating is greater than the maximum input voltage, and whose current rating is greater than the maximum load current. Table 2 lists example Schottky diodes and manufacturers.

#### Input Capacitor

The input current to the step-down converter is discontinuous, therefore a capacitor is required



Table 2—Diode Selection Guide

Diode	Voltage/Current Rating	Manufacture
SK33	30V, 3A	Diodes Inc.
SK34	40V, 3A	Diodes Inc.
B330	30V, 3A	Diodes Inc.
B340	40V, 3A	Diodes Inc.
MBRS330	30V, 3A	On Semiconductor
MBRS340	40V, 3A	On Semiconductor

to supply the AC current to the step-down converter while maintaining the DC input voltage. Use low ESR capacitors for the best performance. Ceramic capacitors are preferred, but tantalum or low-ESR electrolytic capacitors may also suffice.

Since the input capacitor (C1) absorbs the input switching current, it requires an adequate ripple current rating. The RMS current in the input capacitor can be estimated by:

$$I_{C1} = I_{LOAD} \times \sqrt{\frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)}$$

The worst-case condition occurs at  $V_{IN} = 2V_{OUT}$ , where:

$$I_{C1} = \frac{I_{LOAD}}{2}$$

For simplification, choose the input capacitor whose RMS current rating greater than half of the maximum load current.

The input capacitor can be electrolytic, tantalum or ceramic. When using electrolytic or tantalum capacitors, a small, high quality ceramic capacitor, i.e. 0.1μF, should be placed as close to the IC as possible. When using ceramic capacitors, make sure that they have enough capacitance to provide sufficient charge to prevent excessive voltage ripple at input. The input voltage ripple caused by capacitance can be estimated by:

$$\Delta V_{IN} = \frac{I_{LOAD}}{f_s \times C1} \times \frac{V_{OUT}}{V_{IN}} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

### Output Capacitor

The output capacitor (C2) is required to maintain the DC output voltage. Ceramic, tantalum, or low ESR electrolytic capacitors are recommended. Low ESR capacitors are

preferred to keep the output voltage ripple low. The output voltage ripple can be estimated by:

$$\Delta V_{OUT} = \frac{V_{OUT}}{f_s \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times \left(R_{ESR} + \frac{1}{8 \times f_s \times C2}\right)$$

Where L is the inductor value and  $R_{ESR}$  is the equivalent series resistance (ESR) value of the output capacitor.

In the case of ceramic capacitors, the impedance at the switching frequency is dominated by the capacitance. The output voltage ripple is mainly caused by the capacitance. For simplification, the output voltage ripple can be estimated by:

$$\Delta V_{OUT} = \frac{V_{OUT}}{8 \times f_s^2 \times L \times C2} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right)$$

In the case of tantalum or electrolytic capacitors, the ESR dominates the impedance at the switching frequency. For simplification, the output ripple can be approximated to:

$$\Delta V_{OUT} = \frac{V_{OUT}}{f_s \times L} \times \left(1 - \frac{V_{OUT}}{V_{IN}}\right) \times R_{ESR}$$

The characteristics of the output capacitor also affect the stability of the regulation system. The MP2372 can be optimized for a wide range of capacitance and ESR values.

### Compensation Components

MP2372 employs current mode control for easy compensation and fast transient response. The system stability and transient response are controlled through the COMP pin. COMP pin is the output of the internal transconductance error amplifier. A series capacitor-resistor combination sets a pole-zero combination to control the characteristics of the control system.

The DC gain of the voltage feedback loop is given by:

$$A_{VDC} = R_{LOAD} \times G_{CS} \times A_{VEA} \times \frac{V_{FB}}{V_{OUT}} \text{ Where } A_{VEA} \text{ is}$$

the error amplifier voltage gain,  $G_{CS}$  is the current sense transconductance and  $R_{LOAD}$  is the load resistor value.

The system has two poles of importance. One is due to the compensation capacitor (C3) and the output resistor of error amplifier, and the other is



due to the output capacitor and the load resistor. These poles are located at:

$$f_{P1} = \frac{G_{EA}}{2\pi \times C3 \times A_{VEA}}$$

$$f_{P2} = \frac{1}{2\pi \times C2 \times R_{LOAD}}$$

Where  $G_{EA}$  is the error amplifier transconductance, 530 $\mu$ A/V.

The system has one zero of importance, due to the compensation capacitor (C3) and the compensation resistor (R3). This zero is located at:

$$f_{Z1} = \frac{1}{2\pi \times C3 \times R3}$$

The system may have another zero of importance, if the output capacitor has a large capacitance and/or a high ESR value. The zero, due to the ESR and capacitance of the output capacitor, is located at:

$$f_{ESR} = \frac{1}{2\pi \times C2 \times R_{ESR}}$$

In this case, a third pole set by the compensation capacitor (C6) and the compensation resistor (R3) is used to compensate the effect of the ESR zero on the loop gain. This pole is located at:

$$f_{P3} = \frac{1}{2\pi \times C6 \times R3}$$

The goal of compensation design is to shape the converter transfer function to get a desired loop gain. The system crossover frequency where the feedback loop has the unity gain is important.

Lower crossover frequencies result in slower line and load transient responses, while higher crossover frequencies could cause system unstable. A good rule of thumb is to set the crossover frequency to approximately one-tenth of the switching frequency or lower. The switching frequency for the MP2372 is 925kHz, so the desired crossover frequency is equal to or less than 92.5kHz.

Table 3 lists the typical values of compensation components for some standard output voltages with various output capacitors and inductors. The values of the compensation components

have been optimized for fast transient responses and good stability at given conditions.

**Table 3—Compensation Values for Typical Output Voltage/Capacitor Combinations**

V <sub>OUT</sub> (V)	L (μH)	C2 (μF, Ceramic)	R3 (kΩ)	C3 (nF)	C6
1	1	47	3	10	None
1.2	1	47	5.1	6.8	None
1.8	2.2	47	7.5	3.3	None
2.5	2.2 - 4.7	47	10	4.7	None
3.3	2.2 - 4.7	47	15	5.6	None
5	4.7 - 6.8	2 x 22	20	4.7	None
12	6.8 - 10	2 x 22	44.2	2.2	None

To optimize the compensation components for conditions not listed in Table 3, the following procedure can be used.

1. Choose the compensation resistor (R3) to set the desired crossover frequency. Determine the R3 value by the following equation:

$$R3 = \frac{2\pi \times C2 \times f_C}{G_{EA} \times G_{CS}} \times \frac{V_{OUT}}{V_{FB}}$$

Where  $f_C$  is the desired crossover frequency.

2. Choose the compensation capacitor (C3) to achieve the desired phase margin. For applications with typical inductor values, setting the compensation zero,  $f_{Z1}$ , below one forth of the crossover frequency provides sufficient phase margin. Determine the C3 value by the following equation:

$$C3 > \frac{4}{2\pi \times R3 \times f_C}$$

3. Determine if the second compensation capacitor (C6) is required. It is required if the ESR zero of the output capacitor is located at less than half of the 925kHz switching frequency, or the following relationship is valid:

$$\frac{1}{2\pi \times C2 \times R_{ESR}} < \frac{f_S}{2}$$

If this is the case, then add the second compensation capacitor (C6) to set the pole  $f_{P3}$  at the location of the ESR zero. Determine the C6 value by the equation:

$$C6 = \frac{C2 \times R_{ESR}}{R3}$$

## PCB Layout Guide

PCB layout is very important to achieve stable operation. Please follow these guidelines and take Figure2 and 3 for references.

- 1) Keep the path of switching current short and minimize the loop area formed by Input cap, high-side MOSFET and schottky diode.
- 2) Keep the connection of schottky diode between SW pin and input power ground as short and wide as possible.
- 3) Ensure all feedback connections are short and direct. Place the feedback resistors and compensation components as close to the chip as possible.
- 4) Route SW away from sensitive analog areas such as FB.
- 5) Connect IN, SW, and especially GND respectively to a large copper area to cool the chip to improve thermal performance and long-term reliability. For single layer, do not solder exposed pad of the IC.

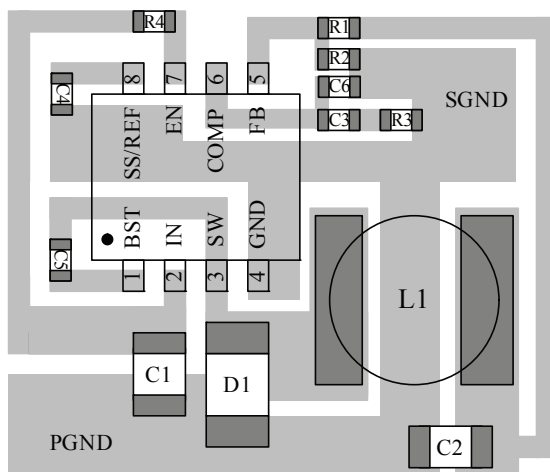
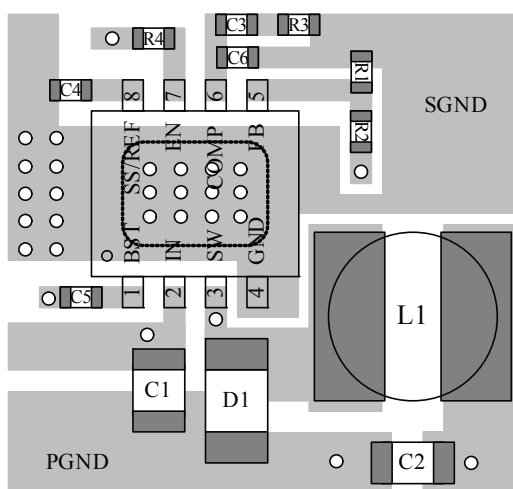
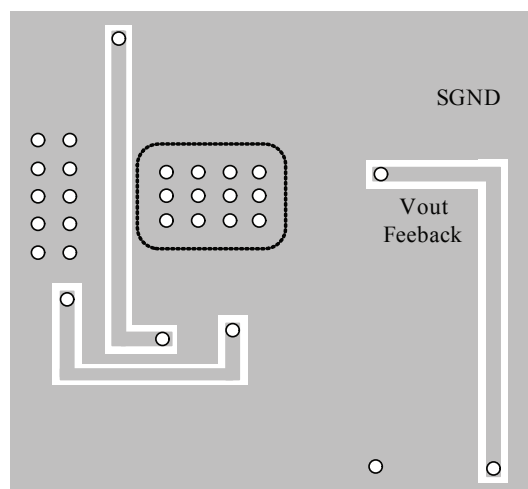


Figure2—PCB Layout for Single Layer



Top Layer



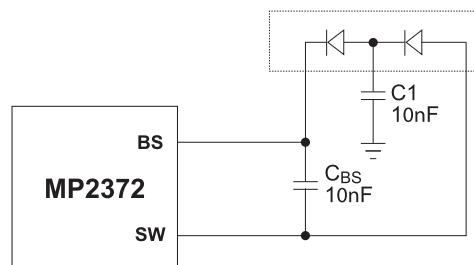
Bottom Layer

Figure3—PCB Layout for Double Layer

### External Bootstrap Diode

Enough voltage of the bootstrap capacitor can enhance the efficiency of the regulator and increase the output capacity. The MP2372 can't output 3.3V/3A when the input voltage is only about 5V. An External charge circuit shown in Figure 4 can be a solution, and the applicable conditions of the circuit are:

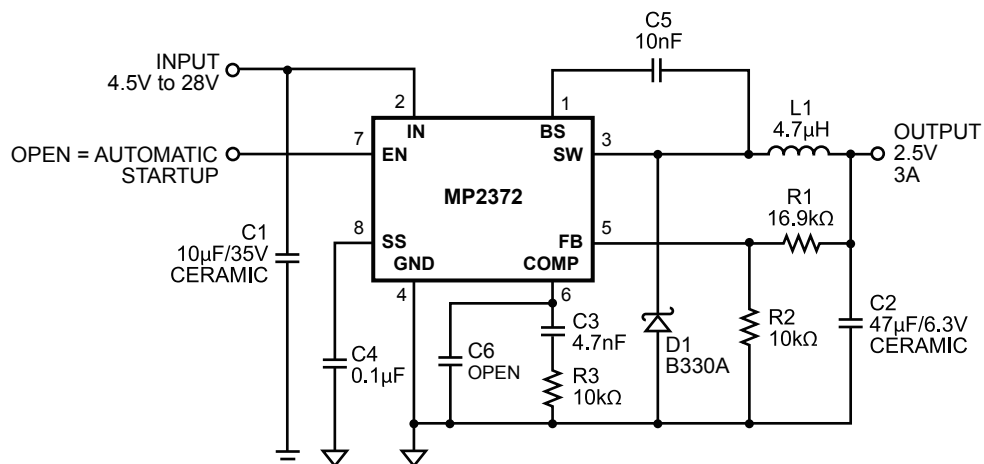
- $V_{IN}$  is only about 5V, and  $V_{OUT}$  is 3.3V or less
- The Duty cycle is high:  $D = \frac{V_O}{V_{IN}} > 60\%$
- The external bootstrap diode circuit can't be applied when  $V_{IN} > 6V$



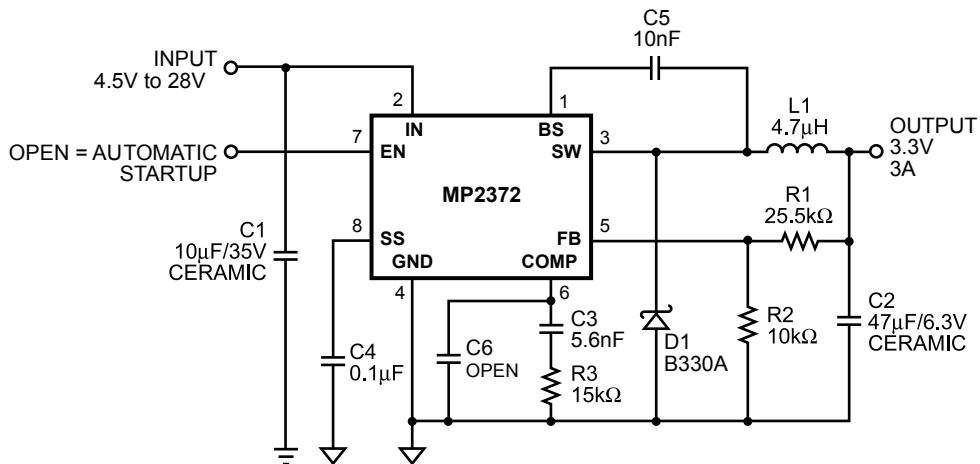
**Figure 4—External Bootstrap Diode Circuit**

D1 integrates two diodes in SOT-523 package such as BAV199T which will not increase the PCB size and the cost. The additional capacitor C1 can be only 10nF.

## TYPICAL APPLICATION CIRCUITS



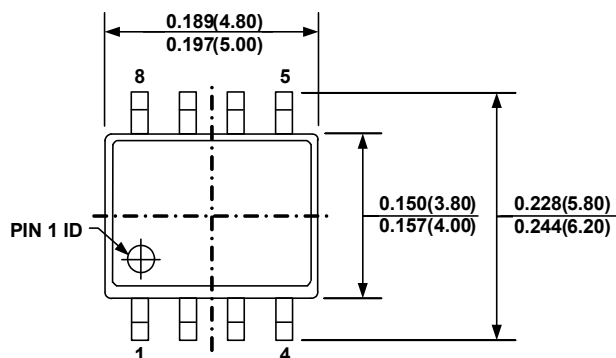
**Figure 5—2.5V Output Typical Application Schematic**



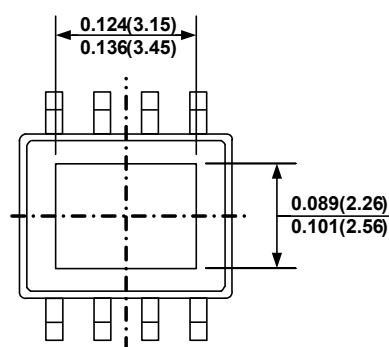
**Figure 6—3.3V Output Typical Application Schematic**

# PACKAGE INFORMATION

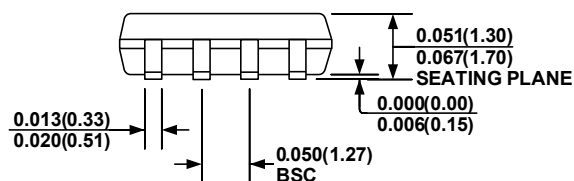
## SOIC8N (EXPOSED PAD)



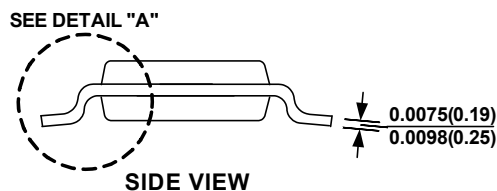
TOP VIEW



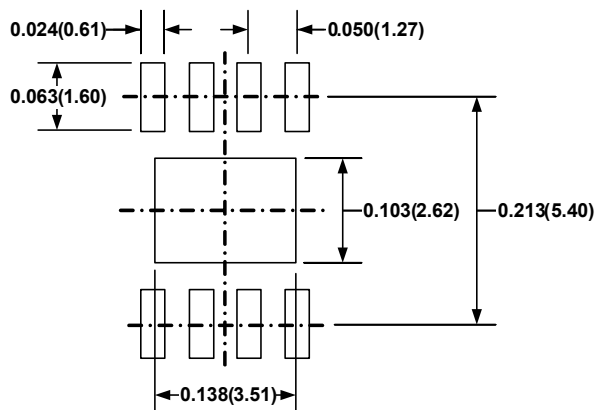
BOTTOM VIEW



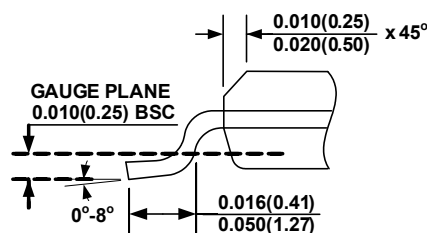
FRONT VIEW



SIDE VIEW



RECOMMENDED LAND PATTERN



DETAIL "A"

### NOTE:

- 1) CONTROL DIMENSION IS IN INCHES DIMENSION IN BRACKET IS IN MILLIMETERS
- 2) PACKAGE LENGTH DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS
- 3) PACKAGE WIDTH DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSIONS
- 4) LEAD COPLANARITY (BOTTOM OF LEADS AFTER FORMING) SHALL BE 0.004" INCHES MAX.
- 5) DRAWING CONFORMS TO JEDEC MS012, VARIATION BA
- 6) DRAWING IS NOT TO SCALE

**NOTICE:** The information in this document is subject to change without notice. Users should warrant and guarantee that third party Intellectual Property rights are not infringed upon when integrating MPS products into any application. MPS will not assume any legal responsibility for any said applications.